

Designed for Electrical applications requiring self-extinguishing properties combined with good mechanical performances, this grade meets the most stringent safety requirements for insulating materials.

Product information

Resin Identification Part Marking Code Continuous Service Temperature	(PA66+PA6)-GF2 >(PA66+PA6)-GF 130		ISO 1043 ISO 11469 IEC 60216-1
Rheological properties	dry/cond.		
Melt volume-flow rate	65/*	cm ³ /10min	ISO 1133
Temperature	275/*	°C	
Load	5/*	kg	
Viscosity number	130/*	cm³/g	ISO 307, 1628
Moulding shrinkage range, parallel	0.3 - 0.6	%	ISO 294-4, 2577
Moulding shrinkage range, normal	0.6 - 0.9	%	ISO 294-4, 2577
Typical mechanical properties	dry/cond.		
Tensile modulus	9400/6200	MPa	ISO 527-1/-2
Tensile stress at break, 5mm/min	130/90	MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	2.5/6	%	ISO 527-1/-2
Flexural modulus	9000/6100 ^{[DS}	^{8]} MPa	ISO 178
Flexural strength	210/160 ^[DS]	MPa	ISO 178
Flexural strain at failure	2.8/-	%	ISO 178
Charpy impact strength, 23°C	55/>60	kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C	8/13	kJ/m²	ISO 179/1eA
Charpy notched impact strength, -30°C	7/-	kJ/m²	ISO 179/1eA
Charpy notched impact strength, -40°C	7/-	kJ/m²	ISO 179/1eA
Ball indentation hardness, H 961/30	205/-	MPa	ISO 2039-1
Poisson's ratio	0.34/0.35 ^[C]		
[DS]: Derived from similar grade			
[C]: Calculated			
Thermal properties	dry/cond.		
Melting temperature, 10°C/min	260/*	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	210/*	°C	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	220/*	°C	ISO 75-1/-2
Ball pressure test	175/-	°C	IEC 60695-10-2
Coefficient of linear thermal expansion	16.7 ^[1] /*	E-6/K	ISO 11359-1/-2
(CLTE), parallel			
Coefficient of linear thermal expansion (CLTE), normal	137 ^[1] /*	E-6/K	ISO 11359-1/-2
[1]: Temperature range: 55°C to 160°C			





Flammability Burning Behav. at 1.5mm nom. thickn Burning Behav. at thickness h Thickness tested UL recognition Glow Wire Flammability Index, 0.75m Glow Wire Flammability Index, 3.0mm Glow Wire Ignition Temperature, 0.75 Glow Wire Ignition Temperature, 3.0m	V-0/* 0.4/* yes/* m 960/- n 960/- mm 775/-	class class mm °C °C °C °C °C	IEC 60695-11-10 IEC 60695-11-10 IEC 60695-11-10 UL 94 IEC 60695-2-12 IEC 60695-2-12 IEC 60695-2-13 IEC 60695-2-13
FMVSS Class	SE		ISO 3795 (FMVSS 302)
Electrical properties Volume resistivity Surface resistivity Electric strength	dry/cond. 1E14/- */1E13 45/-	Ohm.m Ohm kV/mm	IEC 62631-3-1 IEC 62631-3-2 IEC 60243-1
Physical/Other properties Humidity absorption, 2mm Water absorption, 2mm Density	dry/cond. 1.5/* 5.2/* 1370/-	% % kg/m³	Sim. to ISO 62 Sim. to ISO 62 ISO 1183
Injection Drying Recommended Drying Temperature Drying Time, Dehumidified Dryer Processing Moisture Content Melt Temperature Optimum Min. melt temperature Max. melt temperature Screw tangential speed Mold Temperature Optimum Min. mould temperature Max. mould temperature	2 - 4 ≤0.1 285 270 300 ≤0.2 80	% °C °C °C m/s °C °C	
Characteristics			
Processing Delivery form Additives Special characteristics	Injection Moulding Granules Flame retardant, Non-halogenated/Red phosphorous free flame retardant Flame retardant, Heat stabilised or stable to heat		
•	,		

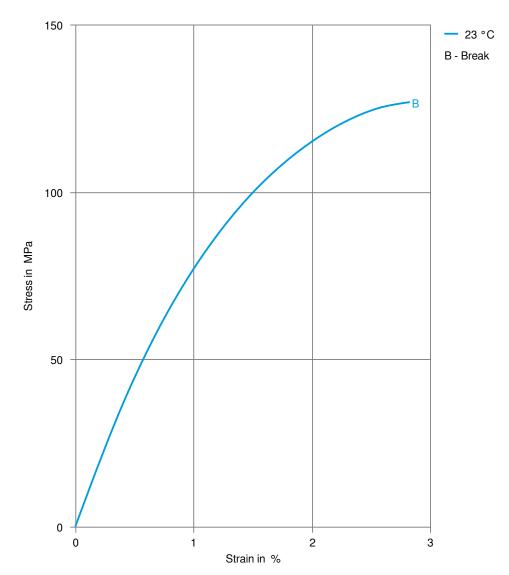




Automotive

OEM	ADDITIONAL INFORMATION
Renault	UB22a, BB/YG, No Spec, Special Part Approval, See Your CE Account Manager.
Renault	UB22b, No Spec, Special Part Approval, See Your CE Account Manager.
Renault	UB22c, No Spec, Special Part Approval, See Your CE Account Manager.
Renault	UB22d, No Spec, Special Part Approval, See Your CE Account Manager.

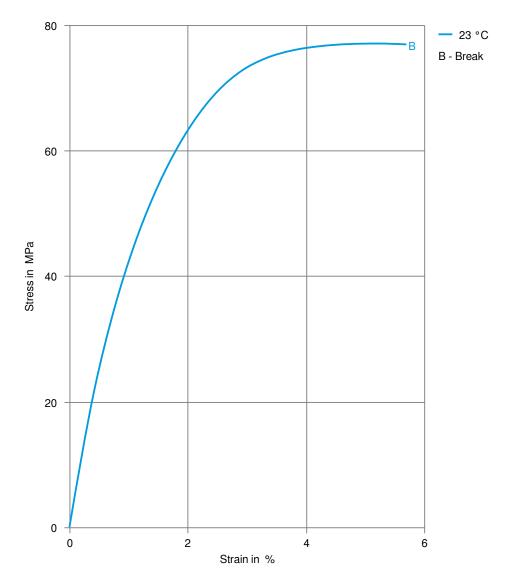
Stress-strain (dry)







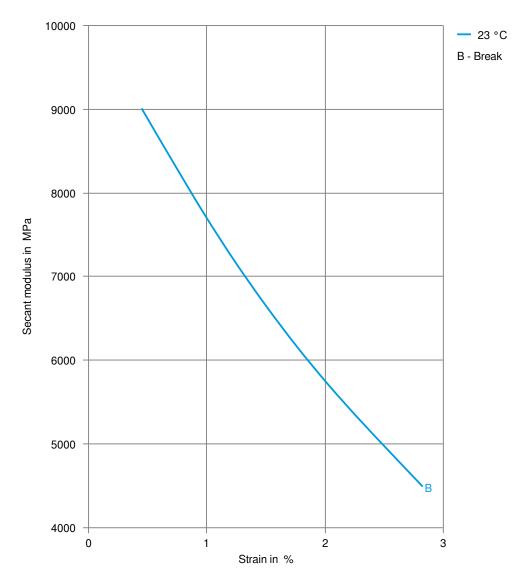
Stress-strain (cond.)







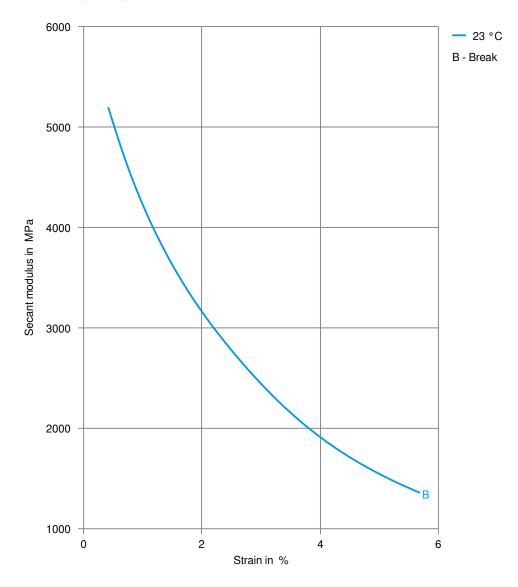
Secant modulus-strain (dry)







Secant modulus-strain (cond.)



Printed: 2025-05-29

Page: 6 of 6

Revised: 2025-02-14 Source: Celanese Materials Database

NOTICE TO USERS: Values shown are based on testing of laboratory test specimens and represent data that fall within the standard range of properties for natural material. These values alone do not represent a sufficient basis for any part design and are not intended for use in establishing maximum, minimum, or ranges of values for specification purposes. Colourants or other additives may cause significant variations in data values. Properties of moulded parts can be influenced by a wide variety of factors including, but not limited to, material selection, additives, part design, processing conditions and environmental exposure. Other than those products expressly identified as medical grade (including by MT® product designation or otherwise), Celanese's products are not intended for use in medical or dental implants. Regardless of any such product designation, any determination of the suitability of a particular material and part design for any use contemplated by the users and the manner of such use is the sole responsibility of the users, who must assure themselves that the material as subsequently processed meets the needs of their particular product or use. To the best of our knowledge, the information contained in this publication is accurate; however, we do not assume any liability whatsoever for the accuracy and completeness of such information. Contained in this publication is accurate; however, we do not assume any liability of the dusers to investigate whether any existing patents are infringed by the use of the materials mentioned in this publication. Moreover, there is a need to reduce human exposure to many materials to the lowest practical limits in view of possible adverse effects. To the extent that any hazards may have been mentioned in this publication, we neither suggest nor guarantee that such hazards are the only ones that exist. We recommend that persons intending to rely on any recommendation or to use any equipment, processing technique or material industion for handling each material th

© 2025 Celanese or its affiliates. All rights reserved. Celanese®, registered C-ball design and all other trademarks identified herein with ®, TM, SM, unless otherwise noted, are trademarks of Celanese or its affiliates. Fortron is a registered trademark of Fortron Industries LLC.